

VUSC1P5R100NA

Datasheet

VUSC1P5R100NA

General Description

V _{(BR)DSS}	R _{DS(ON)_max}	I_D
	10mΩ@10V	
15V	11mΩ@4.5V	8A
13 V	12mΩ@3.8V	δA
	15mΩ@2.5V	

Symbol

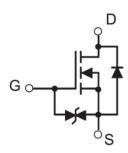
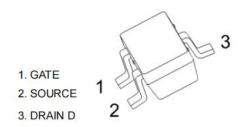


Figure 1 Symbol of VUSC1P5R100NA

Features

- Exceptional on-resistance and maximum DC current
- ESD Protected Gate
- High dense cell design for low R_{DS(on)}

Package Type



Application

- Load / Power Switch
- Interfacing Switching

SOT-23-3L

Figure 2 Package Type of VUSC1P5R100NA

Ordering Information

Product Name	Package			
VUSC1P5R100NA	SOT-23-3L			



VUSC1P5R100NA

Absolute Maximum Ratings (T_A= 25 °C, unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DSS}	15	V
Gate-Source Voltage	V _{GSS}	±12	V
Continuous Drain Current Note1	I_D	8	A
Pulsed Drain Current	I_{DM}	24	A
Total Power Dissipation Note2	P _D	0.45	W
Junction Temperature	$T_{\rm J}$	150	°C
Storage Temperature	T _{STG}	-55 to 150	°C

Thermal Resistance

Parameter	Symbol	Min	Тур	Max	Unit
Thermal Resistance, Junction-to-Ambient Note4	$R_{\theta JA}$		277		°C/W



10mΩ, 15V, N-Channel Power MOSFET

VUSC1P5R100NA

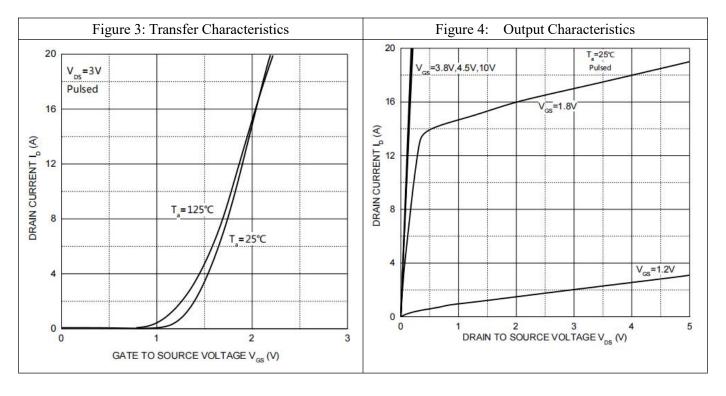
Electrical Characteristics (T_A= 25 °C, unless otherwise specified)

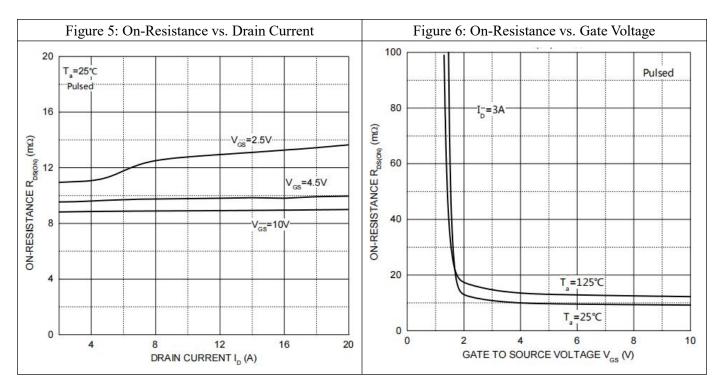
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Statistic Characteristics			•				
Drain-Source Breakdown Voltage	$\mathrm{BV}_{\mathrm{DSS}}$	V _{GS} =0V, I _D = 250uA	15			V	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS}=12V, V_{GS}=0V$			1	uA	
Gate-Body Leakage Current	I_{GSS}	$V_{GS} = \pm 10V, V_{DS} = 0V$			±5	uA	
Gate Threshold Voltage ^{Note3}	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_D=250uA$	0.5	0.8	1	V	
		$V_{GS}=10V$, $I_D=3A$		8.7	10		
Static Drain-Source On-Resistance ^{Note3}	D	V_{GS} = 4.5V, I_{D} = 3A		9.7	11		
Static Drain-Source On-Resistance	R _{DS(ON)}	V_{GS} = 3.8V, I_{D} = 3A		10.2	12	mΩ	
		V_{GS} = 2.5V, I_{D} = 3A		12.8	15		
Forward tranconductance ^{Note3}	gfs	$V_{DS}=5V$, $I_D=3A$		20		S	
Dynamic Characteristics							
Input Capacitance	C _{ISS}	V _{DS} =10V		1800		pF	
Output Capacitance	Coss	$V_{GS}=0V$		230		pF	
Reverse Transfer Capacitance	C_{RSS}	f=1MHz		200		pF	
Total Gate Charge	Q_{g}	V _{DS} =10V		17.9			
Gate-Source Charge	Q_{gs}	V_{GS} =4.5 V		1.5		nC	
Gate-Drain Charge	Q_{gd}	$I_D=3A$		4.7			
Switching Parameters			•				
Turn-on Delay Time	t _{d(on)}	V _{DD} = 10V		2.5			
Turn-on Rise Time	t _r	$V_{GS}=10V$		7.2			
Turn-off Delay Time	$t_{ m d(off)}$	$R_L=1.2\Omega$		49		ns	
Turn-off Fall Time	t_{f}	$R_{GEN}=3\Omega$		10.8			
Diode Characteristics							
Diode Forward Voltage Note3	V_{SD}	$V_{GS}=0V$, $I_{S}=2A$		0.75	1.2	V	

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. This test is performed with no heat sink at T_A =25C.
- 3. Pulse Test: Pulse With ≤300µs, Duty Cycle≤2%.
- 4.Device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.

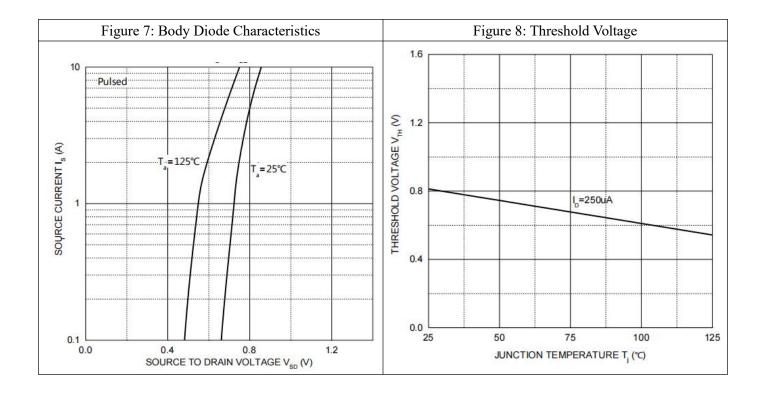
Typical Performance Characteristics







VUSC1P5R100NA

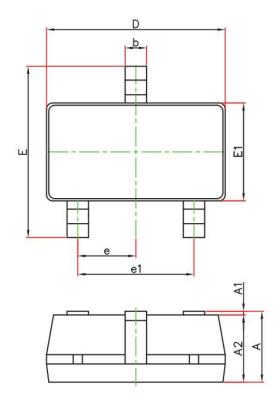


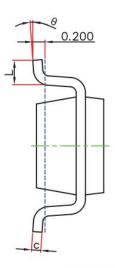


VUSC1P5R100NA

Mechanical Dimensions:

SOT-23-3L Package Information





Symbol	Dimensions	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
С	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E1	1.500	1.700	0.059	0.067	
Е	2.650	2.950	0.104	0.116	
е	0.950(BSC)		0.037	(BSC)	
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	



VUSC1P5R100NA

NOTICE

Hangzhou VMD Semiconductor Co., Ltd (VMD) reserves the right to make changes without notice in order to improve reliability, function or design and to discontinue any product or service without notice. Customers should obtain the latest relevant information before orders and should verify that such information is current and complete. All products are sold subject to VMD's terms and conditions supplied at the time of order acknowledgement.

VMD, its affiliates, agents, and employees, and all persons acting on its or their behalf, disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product. VMD disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify VMD's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

VMD warrants performance of its hardware products to the specifications at the time of sale, testing, reliability and quality control are used to the extent VMD deems necessary to support this warrantee. Except where agreed upon by contractual agreement, testing of all parameters of each product is not necessarily performed.

VMD does not assume any liability arising from the use of any product or circuit designs described herein. Customers are responsible for their products and applications using VMD's components. To minimize risk, customers must provide adequate design and operating safeguards.

VMD does not warrant or convey any license to any intellectual property rights either expressed or implied under its patent rights, nor the rights of others. Reproduction of information in VMD's data sheets or data books is permissible only if reproduction is without modification or alteration. Reproduction of this information with any alteration is an unfair and deceptive business practice.

VMD is not responsible or liable for such altered documentation. Resale of VMD's products with statements different from or beyond the parameters stated by VMD for that product or service voids all express or implied warrantees for the associated VMD product or service and is an unfair and deceptive business practice.

All Rights Reserved.



Via-Media Semiconductor Limited Company

http://www.vmdsemi.com

Main Sites:

- Headquarters

Hangzhou Via-Media Semiconductor Co., LTD. 1305-1306, Building 71, No. 90, Wensan Road, Xihu District, Hangzhou, Zhejiang Province, P.R. China

Tel: +86-0571-8515 0563

Shanghai

Shanghai R&D Center. 1506~1508, Xinyin Building, 888 Yishan Road, Shanghai, P.R of China Tel: +86- 021-54201999

Xi'an

Xi'an R&D Center 1703B, Building A, Greenland Center, Jinye Road, High-Tech Zone, Xi'an, Shaanxi, P.R of China

Chengdu Office

Chengdu Winhi Semiconductor Co., LTD. Floor 15, Building 5, No. 171, Hele 2nd Street, Chengdu, Sichuan Province, P.R. China Tel: +86-028-8505 0771

Shenzhen

Shenzhen Sales Center. 17B, No.1 Phoenix Building, 2008 Shennan Road, Shenzhen, P.R of China Tel: +86-0755- 82570682